

**Effect of Chemical Etching by Sulfuric Acid or H₂O₂-
NH₃ Mixed Solution on the Photocatalytic Activity of Rutile TiO₂
Nanorods**

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Abstract

Rutile TiO₂ nanorods synthesized by hydrothermal treatment were etched by addition of H₂O₂-NH₃ or H₂SO₄ solution. The etched rutile TiO₂ nanorods were characterized by TEM, SEM, XRD, and specific surface area measurements. New crystal faces were generated on rutile TiO₂ nanorods by means of chemical etching. In the case of treatment with H₂O₂-NH₃ solution, the shape of the rutile TiO₂ nanorod changed to a sepal-like structure with reaction time. The dissolution of rutile TiO₂ nanorod mainly proceeded along [001] direction. When treated with sulfuric acid, the end [(111) face] of the rutile TiO₂ nanorod was gradually etched. The rutile TiO₂ nanorod finally exposed (001) and (021) faces during prolonged treatment time. In both cases, rutile TiO₂ nanorods were differently etched. The etched rutile TiO₂ nanorod showed higher photocatalytic activity for degradation of toluene in gas phase than the original particles.

1. Introduction

TiO₂ photocatalysts have been the focus of much attention due to their high photocatalytic activity as well as their chemical stability. The photocatalytic activity of TiO₂ is the result of an interaction among a series of parameters such as phase composition, electronic structure, particle size, exposed surface area, degree of aggregation, mobility of charge carriers and adsorption of molecules from gas or aqueous phase [1]. It is therefore important to develop a method to understand and control those properties due to the plurality of variables driving the nature of photocatalytic activity. In this work, the effect of chemical etching of nanoparticles was investigated. Among the various polymorphs of TiO₂, rutile TiO₂ has some advantages over anatase, such as higher chemical stability and higher refractive index. It is of fundamental significance to explore mild synthetic techniques by which particle shapes, nano- and micro-meter-scale morphologies, and crystallinity are well defined and controlled [2-4]. Moreover, surface chemistry of single crystalline rutile particles has been the subject of intensive studies because their chemical activity depends greatly on surface structures [5].

Etching of nanoparticles has been discussed in previous reports. Whetten reported selective etching of particles on the basis of differences in their chemical

reactivity due to, for example, variations in defect density and surface faceting [6]. As concerns the modification of the surface structure of TiO_2 , attempts to enlarge the surface areas of various materials have been made using various surface etching processes such as a photoelectrochemical etching process in aqueous sulfuric acid [7, 8]. A conventional chemical process for etching TiO_2 is immersion in concentrated sulfuric acid at a high temperature. In addition, Taguchi et al. reported that HF and hot sulfuric acid treatment resulted in the formation of new crystal faces on both rutile and anatase TiO_2 particles [9]. Moreover, Ohtani et al. reported that aqueous hydrogen peroxide (H_2O_2) – ammonia (NH_3) treatment gave a pure anatase crystalline phase from Degussa P25 containing both anatase and rutile crystallites [10]. Indeed, this technique can be used to separate anatase particles by selective dissolution of rutile. Here, we report that each of these chemical treatments leads to the formation of new crystal faces on rutile TiO_2 particles.

Chemical etching of rutile TiO_2 nanoparticles was carried out in this work. Chemical etching can be used to increase the number of new exposed crystal faces, especially in the case of H_2SO_4 , similar to the process reported for synthesis using PVP. Exposed crystal face-selective etching of TiO_2 in H_2O_2 - NH_3 solution is also demonstrated in this paper. The resulting products were fully characterized. The

photocatalytic activities of different samples for oxidation of toluene were found to be correlated with the crystal shapes of the rutile TiO₂ nanorods. We demonstrated that the crystal surface structure of TiO₂ nanorods can be controlled by adjusting the etching time of H₂O₂-NH₃ or H₂SO₄ solution. These TiO₂ nanorods are expected to show high levels of photocatalytic activity due to the different crystal faces.

2. Experimental

2.1. Chemicals.

All of the chemical reagents used in this study were commercial products and were used without further treatment. Titanium trichloride (TiCl₃), sodium chloride (NaCl), hydrogen peroxide (H₂O₂), ammonia solution (NH₃), sulfuric acid (H₂SO₄), lead nitrate (Pb(NO₃)₂), and nitric acid (HNO₃) were purchased from Wako (all of reagent grade), and toluene was purchased from Aldrich. TiO₂ (MT-600B, Tayca), a rutile with an average surface area of 25-35 m² g⁻¹, was used as a reference photocatalyst.

2.2. Procedure for chemical etching

The starting material for rutile TiO₂ nanorods was synthesized by using aqueous

titanium trichloride (TiCl_3 , 0.15 M) solution containing sodium chloride (NaCl , 5 M) with hydrothermal treatment at 200 °C for 6 h [11].

To aqueous hydrogen peroxide (H_2O_2 , 30%; 50 mL) in a flask was added aqueous ammonia (NH_3 , 2.5%; 5.0 mL) under magnetic stirring. A synthesized rutile TiO_2 (0.5 g) was added to the H_2O_2 - NH_3 mixed solution and stirred for 0.5 h to 4 h at room temperature. After such treatment, the TiO_2 particles were separated by filtration, washed with water several times, and dried at 70 °C in air.

For treatment of TiO_2 particles with sulfuric acid, concentrated sulfuric acid was used as obtained. For etching with sulfuric acid, TiO_2 powder (0.5 g) was added to a flask containing sulfuric acid (20 mL) at room temperature. The mixture was stirred for 6 h to 1 week. After the treatment, the TiO_2 particles were filtered and washed with 1% aqueous ammonia solution and then with deionized water.

2.3. Characterization

The morphology of the samples was observed by field emission scanning electron microscopy (FE-SEM; JEOL, JSM-6701FONO) and transmission electron microscopy (TEM; Hitachi, H-9000NAR). The specific surface area was determined with a surface area analyzer (Quantachrome, Autosorb-1) by using the Brunauer-Emmett-Teller

method [12].

The crystal structures of the powders were confirmed by using an X-ray diffractometer (Rigaku, MiniFlex II) with Cu K α radiation ($\lambda = 1.5405 \text{ \AA}$). Crystal structures of TiO₂ nanorods etched by H₂O₂ with NH₃ or H₂SO₄ retained the rutile phase. No peak assigned to anatase or brookite phase after chemical etching was observed by XRD analyses (data not shown).

2.4. Photocatalytic activity measurements

Photocatalytic activities of rutile TiO₂ nanorods before and after etching treatment were evaluated by measuring the changes in concentrations of toluene in gas phase. At the same time, the amount of evolved CO₂ as a result of photocatalytic mineralization of toluene was also observed by GC as a function of irradiation time.

A Tedlar bag (AS ONE Co. Ltd.) was used as the photoreactor vessel. One hundred mg of TiO₂ powder was spread on the bottom of a glass dish and the dish was placed in a reaction vessel with a volume of 125 cm³. Then 100 ppm of toluene was prepared in the vessel by injection of saturated toluene gas. Irradiation was conducted at room temperature after an equilibrium between the gas and the adsorbed toluene had been reached. A 500 W Xe-lamp (USHIO Co. Ltd., SX-UI501XQ) was used as a light source.

The light beam was passed through a UV-35 filter to cut off wavelengths shorter than 350 nm. Fine stainless meshes were used as neutral density filters to adjust the irradiation intensity (30 mW cm^{-2}). After the irradiation was started, the evolved carbon dioxide concentration was measured using a gas chromatograph (Shimadzu Model GC-8A and GC 14A) equipped with a Flame Ionization Detector (FID) and a methanizer (GL Sciences, MT-221). Toluene was analyzed by a gas chromatograph (Shimadzu GC-1700AF) equipped with an FID and a TC-1 capillary column (length, 30 m; i.d., 0.25 mm; film thickness, 0.25 μm).

3. Results and discussion

3.1. Rutile TiO_2 nanorod etching in H_2O_2 - NH_3 solution

Rutile TiO_2 can be dissolved in H_2O_2 - NH_3 mixed solution. Ohtani et al. reported that separation of anatase was achieved by selective dissolution of rutile from P25 [10]. They also reported that the rate of rutile dissolution was faster than that of anatase in an H_2O_2 - NH_3 mixture. We therefore used a small amount of NH_3 solution to prevent complete dissolution of rutile TiO_2 nanorods prepared by the hydrothermal process.

TiO_2 powder (0.5 g) was suspended in a H_2O_2 - NH_3 mixed solution (50 mL) and the

mixture was stirred for 0.5 h to 4 h at room temperature, leading to dissolution of the solid to give a light-yellow sol. According to Ohtani et al. [10], the yellow color of the solution during and after treatment suggested the formation of a Ti^{4+} - H_2O_2 complex. Ohtani et al. also suggested that NH_3 might enhance the selective dissolution of rutile TiO_2 . TEM and SEM observations revealed that the addition of a small amount of NH_3 resulted in dissolution of the rutile powder. In the mixture containing 5.0 mL of aqueous 2.5% NH_3 , the dissolution proceeded rapidly in the initial 0.5 h and then proceeded gradually. We used synthesized rutile TiO_2 nanorods (TiCl_3 -0.15 M and NaCl -5 M) to observe the crystal faces formed on TiO_2 particles [11]. Figure 1 shows TEM and SEM images of a rutile TiO_2 nanorod prepared according to reference [11]. The assignment of crystal faces was reported previously [11]. SEM and TEM images of the rutile TiO_2 nanorod after treatment with H_2O_2 - NH_3 mixed solution for different time periods are shown in Figure 2. The etching rate in H_2O_2 - NH_3 solution was very fast. By comparing the structure with that before etching (Fig. 1), we found that the end of the rutile TiO_2 nanorod is selectively etched with increased reaction time. As a result, the tip of the rutile TiO_2 nanorod becomes a sepal-like structure after a reaction time of 4 h. However, when the reaction time was increased from 0.5 h to 4 h, the rutile TiO_2 structure became thinner. As previously reported [11, 13], SAED patterns of the exposed surface of the

end of the rod and side surfaces of the rod were assigned to (111) and to (001) and (110), respectively (data not shown). The areas of exposed (111) and (001) crystal faces gradually decreased with increase in reaction time. At the same time, a cone-shaped rod end was newly exposed and a crystal face assigned to the (110) face gradually decreased as shown in Figure 2.

To determine the site at which oxidation predominantly proceeds, we carried out photodeposition studies of PbO_2 . PbO_2 was deposited on the oxidation site of TiO_2 by oxidation of Pb^{2+} ions dissolved in aqueous phase, as was reported previously [11, 14]. Figure 3 shows TEM and SEM images of PbO_2 -deposited rutile TiO_2 nanorods that were prepared with 1 h of etching time. The deposited PbO_2 was analyzed by EDX (figure not shown). In previous papers [11, 14], we presented TEM and SEM images of rutile TiO_2 particles showing PbO_2 deposits, which were loaded on the particles by UV irradiation of the Pt-deposited TiO_2 powder. However, in this study, we only confirmed the oxidation site by using PbO_2 deposition technique because the number of reduction sites of rutile nanorod treated with H_2O_2 - NH_3 solution remarkably decreased. Therefore, assignment of reduction site of rutile nanorod by Pt deposition is rather difficult. Figure 3 shows that the PbO_2 particles were deposited on the (111) and (001) faces. The results shown in Figure 3 indicate that the oxidation sites on the rutile particles are on the

exposed new cone-shaped rod ends. These results agree with the results of our previous studies [11, 14]. Therefore, the results suggest that effective separation of oxidation sites of rutile TiO₂ nanorods is an important factor for high efficiency of decomposition of toluene.

3.2. Rutile TiO₂ etching in H₂SO₄ solution

In studies of photoelectrochemistry of a TiO₂ electrode, in order to remove surface damage, researches after treat rutile crystals with concentrated sulfuric acid at about 200-250 °C before measurements [15]. Ohno et al. reported that similar H₂SO₄ treatment at 200 °C generated new faces of rutile particles [9]. We tried this treatment for TiO₂ powder containing rutile particles. However, the color of rutile TiO₂ particles changed from white to pale gray and the shape of the particles began to deform at high temperatures (100 °C and 200 °C) as shown in Fig. 4. It is plausible that the sizes of TiO₂ particles in our study are smaller than those reported previously [9]. The conditions for etching of TiO₂ nanorods by sulfuric acid are thought to be too severe to expose new crystal faces. Therefore, we tried sulfuric acid treatment for the rutile TiO₂ powder at room temperature. Figure 5 shows TEM and SEM images of rutile particles after sulfuric acid treatment for different time periods. TEM and SEM images before

etching (Fig. 1) revealed that the structures were nanorods with triangular-like tips. The (001) face was exposed as a result of dissolution of the (111) face by H₂SO₄ etching, its shape is similar to that of rutile TiO₂ synthesized using PVP in the previous study [14].

When the period of etching was increased from 6 h to 72 h, the shape of the end of the rod changed from a triangular-like tip (composed of four triangular-shaped faces with one vertex) to a trapezoid-like tip (composed of four trapezoidal-shaped faces and one square top) (Fig. 5). At the same time, generation of another new face began. After treatment for one week, a different kind of new face had developed on each particle. As seen in Figures 5e and 5e', this new face is assigned to the (021) face, which had been already assigned from a previous paper [9]. As a result, (001) and (021) faces are generated at the tip of TiO₂ and, at the same time, the (111) face disappears from the rutile particle. However, no change in the (110) face of the rutile TiO₂ particle was detected after treatment. Consequently, the surface morphology of the rutile TiO₂ rod was controlled by changing the etching period.

3.3. Photocatalytic activity for toluene decomposition

Figure 6 shows photocatalytic evolution of CO₂ as a result of degradation of toluene on rutile TiO₂ particles after etching at light intensity of 30 mW cm⁻².

Photocatalytic activity levels of etched TiO_2 were much higher than those of MT-600B (reference TiO_2) and those before etching of TiO_2 . Photocatalytic activity levels of TiO_2 nanorods after etching were higher than those of TiO_2 nanorods prepared before etching. The photocatalytic activity of the TiO_2 particles showed dependence on the time of etching, though S_{BET} showed no dependence on the etching period (see Table 1). These results suggest that the particle size or the surface area does not play an important role in this reaction. The newly exposed crystal surface or the ratio of oxidation and reduction sites is an important factor for improvement of photocatalytic activity of toluene degradation.

Figure 6a shows the time course of CO_2 evolution in degradation of toluene over TiO_2 particles before and after treatment with $\text{H}_2\text{O}_2\text{-NH}_3$ solution. With $\text{H}_2\text{O}_2\text{-NH}_3$ treatment, the activities of toluene were higher than those before etching, suggesting that etching is effective for improving toluene oxidation. The effect of $\text{H}_2\text{O}_2\text{-NH}_3$ treatment was significant for a reaction time of 1 h. TiO_2 etched with 1 h of reaction time showed the highest photocatalytic activity among the treatments of TiO_2 samples even though all had similar surface areas. Our results suggest that the balance between oxidation and reduction sites is important for high photocatalytic activity in the $\text{H}_2\text{O}_2\text{-NH}_3$ etching method. The rate-determining step of the reaction is thought to be, not

reduction of oxygen by photoexcited electrons, but oxidation of toluene by holes generated photocatalytically because toluene is difficult to oxidize. Therefore, it is thought that photocatalytic activity of a rutile TiO₂ nanorod increases with increase in the oxidation sites on the rutile TiO₂ nanorod. The results suggest that there is a synergetic effect between oxidation and reduction sites in etched TiO₂ particles in H₂O₂-NH₃ solutions.

Figure 6b shows the time course of CO₂ evolution in degradation of toluene over TiO₂ particles before and after treatment with an H₂SO₄ solution. As-synthesized rutile TiO₂ nanorods with PVP exposed by (001) faces have been shown to have high photocatalytic efficiency [14]. In this experiment, we expected high photocatalytic activities to be exhibited because of similar shaped TiO₂ prepared by hydrothermal method with PVP [14]. Commercially available MT-600B TiO₂ was also used as a reference for comparison. It was found that etched TiO₂ particles exhibited a higher degradation rate of toluene than that before etching and that the degradation efficiency was higher than that of reference TiO₂. Furthermore, we expected that the etched TiO₂ particles with a higher percentage of (001) faces would have photocatalytic performance, demonstrating high catalytic activity of the (001) face with strong oxidation sites. However, TiO₂ etched with 15 h of reaction time in H₂SO₄ solution

showed the highest photocatalytic activity among the etched TiO₂ particles, despite a small exposed (001) face. Under this etching condition, the new exposed crystal face, (001), was thought to play an important role in improvement of photocatalytic activity of rutile TiO₂ nanorods. We previously reported that the exposed crystal face, (001), showed stronger oxidation power than that of the (111) crystal face [14]. TiO₂ etched for longer than 15 h showed lower photocatalytic activity than that of TiO₂ etched for 15 h despite having a larger (001) exposed crystal face. A possible reason for this is that the (021) newly exposed surface on etched TiO₂, which is shown in SEM images in Figure 5, might prevent oxidation reaction of reactants, resulting in a decrease in the efficiency of photocatalytic reaction. However, our results suggest that the photocatalytic activity of the samples for toluene degradation was affected by the newly exposed crystal surface of rutile TiO₂.

4. Conclusion

We have demonstrated that the surface structure of TiO₂ particles can be controlled by means of chemical etching. The etched TiO₂ particles showed high photocatalytic activities due to newly exposed crystal faces. Addition of reagents of chemical etching enabled control of the exposed crystal faces of rutile TiO₂ nanorods in crystallization.

The morphology of rutile crystals can be controlled by changing the reagent of chemical etching and the etching period. We showed that etched rutile TiO₂ possessed higher levels of CO₂ evolution activity than those of MT-600B and TiO₂ without treatment of chemical etching under UV light irradiation. It was found that the photocatalytic activity depends not on surface area but on surface structure of the TiO₂ nanorods, suggesting that electron-hole pair recombination plays an important role during the photodegradation of toluene, at least under the present experimental conditions.

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Table 1. Specific surface areas of rutile TiO₂ nanorod samples.

Sample	Conditions	BET surface area (m ² /g)
MT-600B		25-35
Before etching		18.6
H ₂ O ₂ -NH ₃ -0.5h	0.5h stirring	16.1
H ₂ O ₂ -NH ₃ -1h	1h stirring	15.3
H ₂ O ₂ -NH ₃ -2h	2h stirring	15.9
H ₂ O ₂ -NH ₃ -4h	4h stirring	15.3
H ₂ SO ₄ -6h	6h stirring	17.4
H ₂ SO ₄ -15h	15h stirring	15.7
H ₂ SO ₄ -24h	24h stirring	18.5
H ₂ SO ₄ -72h	72h stirring	16.6
H ₂ SO ₄ -1 week	168h stirring	17.0

Figure Captions

Figure 1. (a) TEM image and (b) SEM image of rutile particles present in the TiO₂ powder used in this study.

Figure 2. TEM images and SEM images of rutile particles after treatment with aqueous H₂O₂-NH₃ solution. The etching periods were about (a) 0.5 h, (b) 1 h, (c) 2 h and (d) 4 h.

Figure 3. (a) TEM image and (b) SEM image of a rutile TiO₂ nanorod (H₂O₂-NH₃-1h) on which PbO₂ particles were photodeposited.

Figure 4. TEM image of rutile particle after treatment with sulfuric acid at 200 °C.

Figure 5. TEM images and SEM images of rutile particles after treatment with sulfuric acid. The etching periods were about (a) 6 h, (b) 15 h, (c) 24 h, (d) 72 h and (e) 1 week.

Figure 6. Time profiles of CO₂ evolution of toluene decomposition over TiO₂ particles prepared by treatment with (a) H₂O₂-NH₃ and (b) sulfuric acid at light intensity of 30 mW cm⁻². The experimental conditions were: [toluene]_i = 100 ppm, [TiO₂] = 10.4 mg/cm², UV light ($\lambda > 350$ nm) irradiated.

Figure(s)
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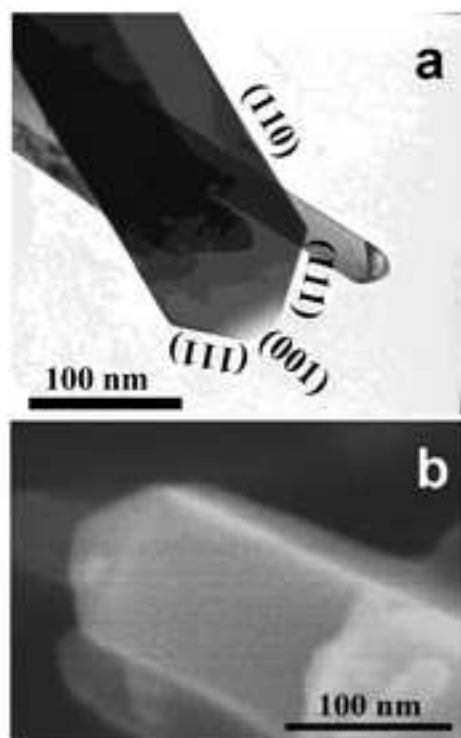


Figure 1.

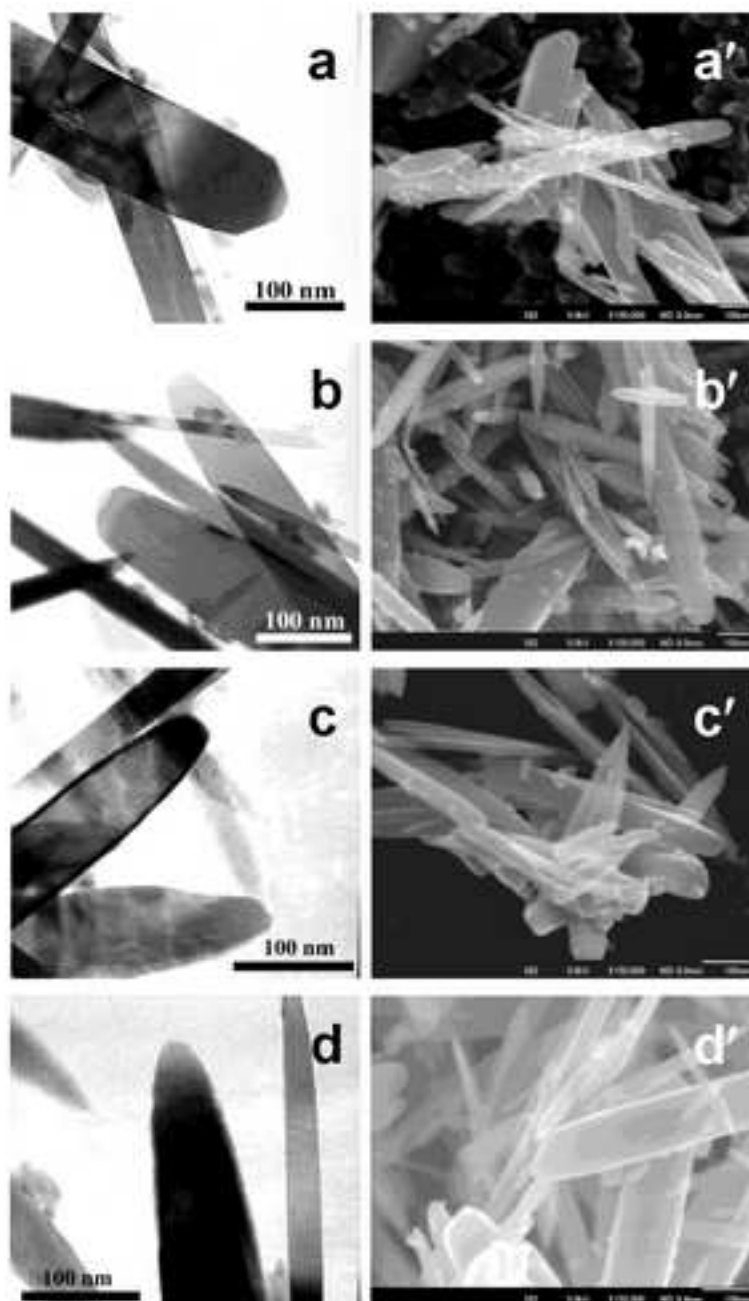


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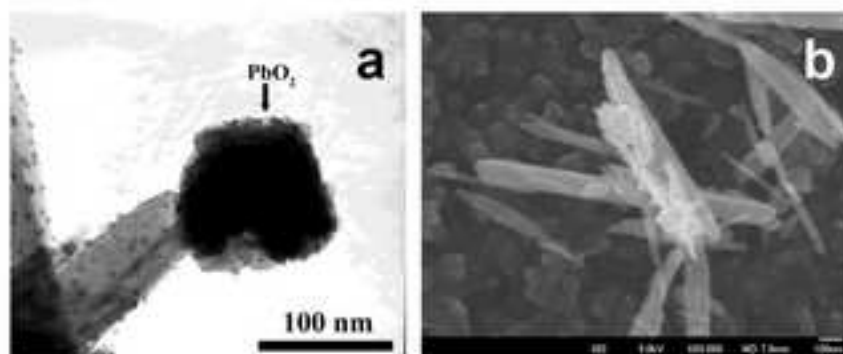


Figure 3.

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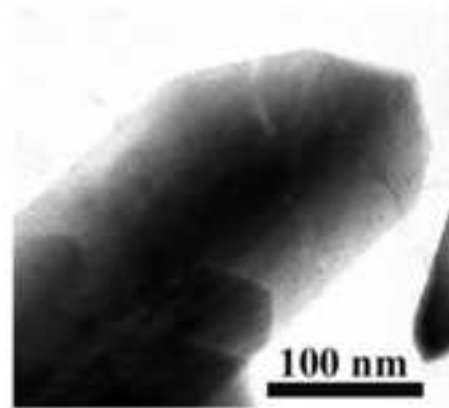


Figure 4.

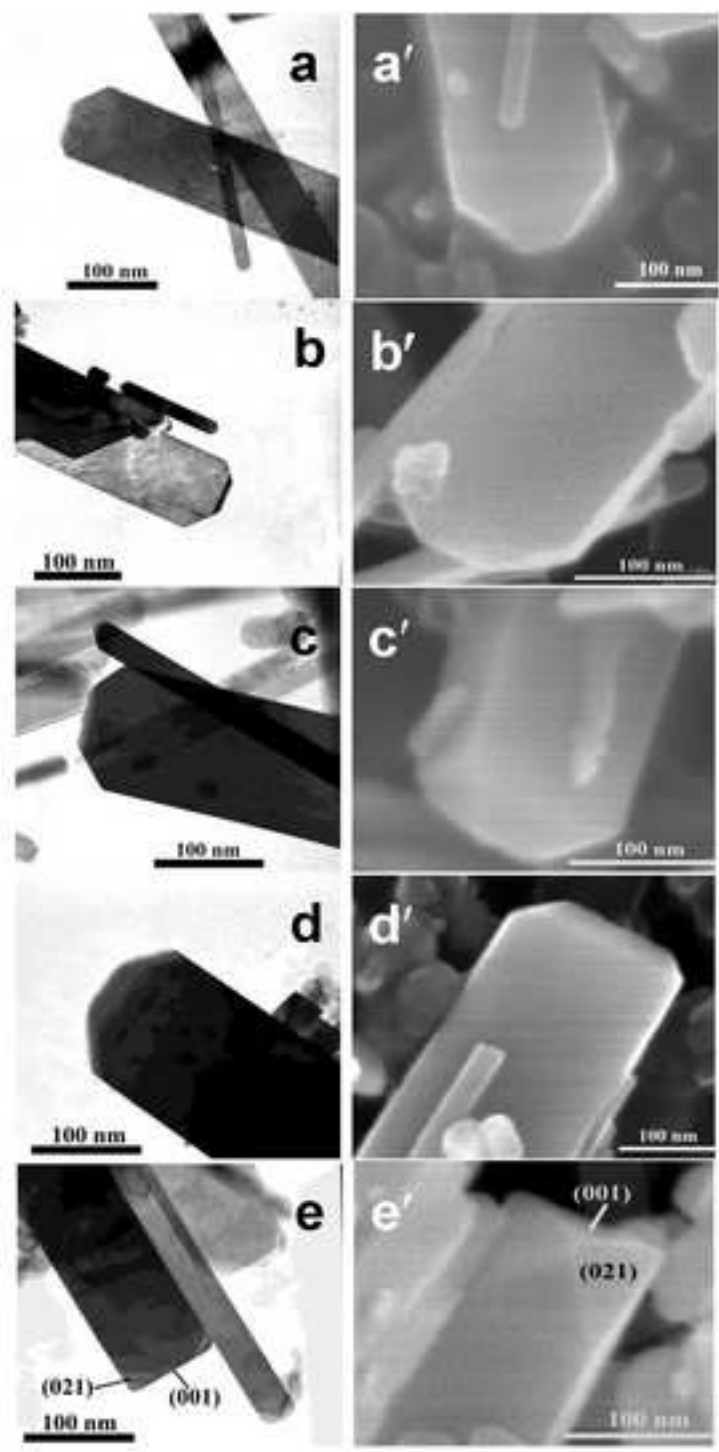


Figure 5.

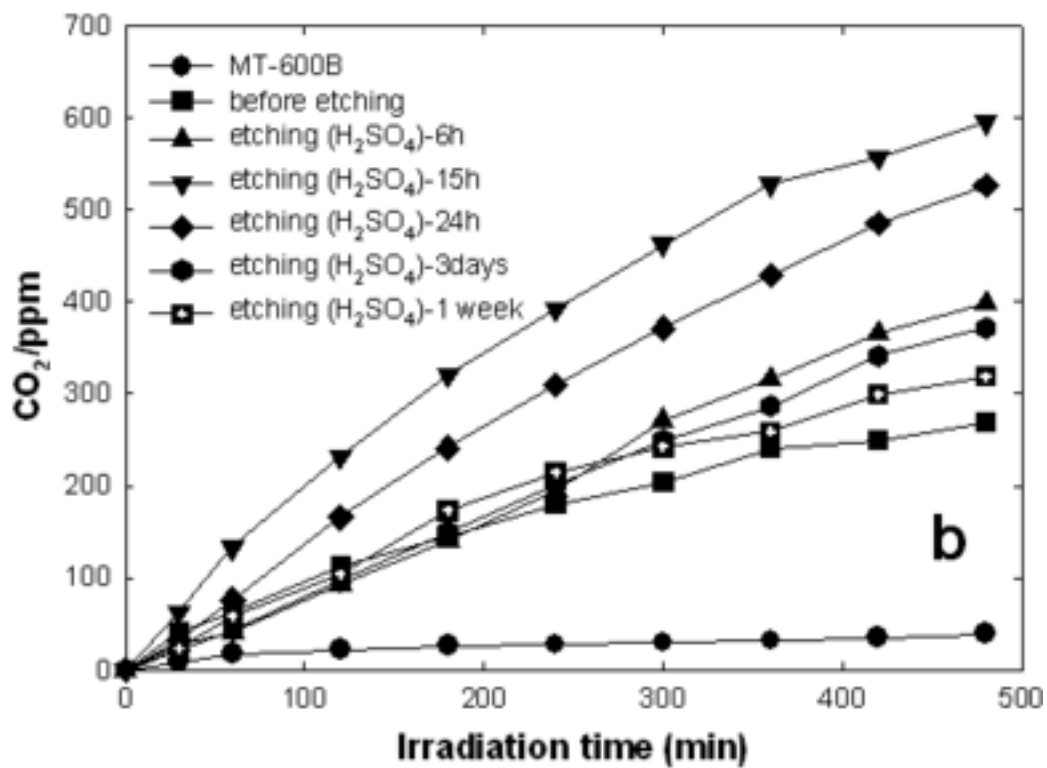
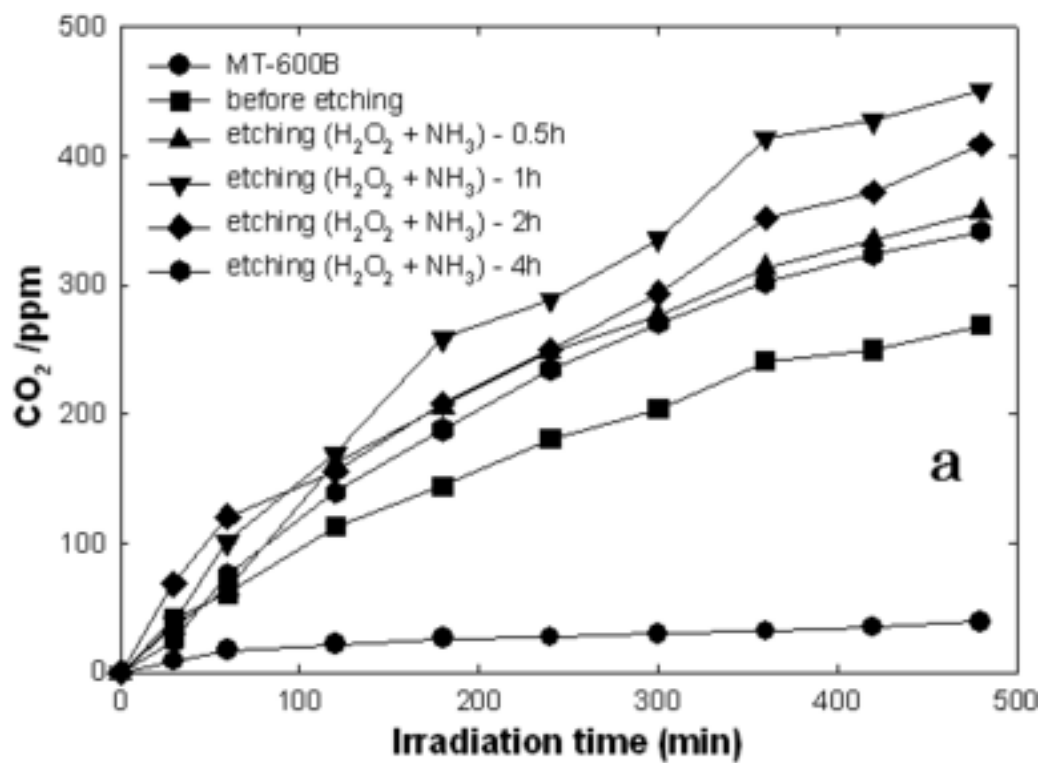


Figure 6.